

Dual N-Channel Enhancement MOSFET

Description

WM02DN70A uses advanced trench technology that has been especially tailored to minimize the on-state resistance. This device is suitable for un-directional or bidirectional load switch, facilitated by its common-drain configuration.

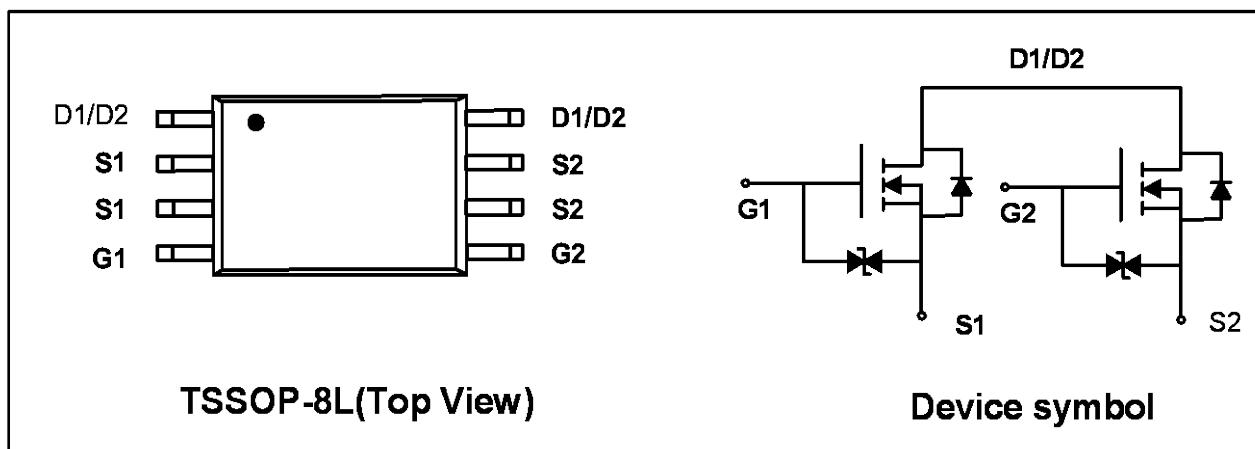
| $V_{(BR)DSS}(V)$ | $I_D(A)$ | $R_{DS(on)}TYP\text{ (m}\Omega\text{)}$ |
|------------------|----------|---|
| 20 | 7 | 11 @ $V_{GS}=10V$ |
| | | 12 @ $V_{GS}=4.5V$ |
| | | 15 @ $V_{GS}=2.5V$ |

Features

- Super high dense cell for low $R_{DS(ON)}$
- RoHS Compliant and Halogen-Free
- ESD protected: Class 2

Applications

- Battery protection
- Load switch

Schematic & PIN Configuration**Absolute Maximum Rating ($T_A=25^\circ C$ unless otherwise noted)**

| Parameter | | Symbol | Value | Unit |
|--|-------------------|----------------|------------|------------|
| Drain-Source Voltage | | V_{DS} | 20 | V |
| Gate-Source Voltage | | V_{GS} | ± 12 | V |
| Continuous Drain Current | $T_A=25^\circ C$ | I_D | 7 | A |
| | $T_A=100^\circ C$ | | 4.4 | |
| Pulsed Drain Current ¹ | | I_{DM} | 28 | A |
| Total Power Dissipation | $T_A=25^\circ C$ | P_D | 1.5 | W |
| Operating Junction and Storage Temperature Range | | T_J, T_{STG} | -55 to 150 | $^\circ C$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|-----------------|-------|--------------|
| Thermal Resistance from Junction-to-Ambient ² | $R_{\theta JA}$ | 83.3 | $^\circ C/W$ |

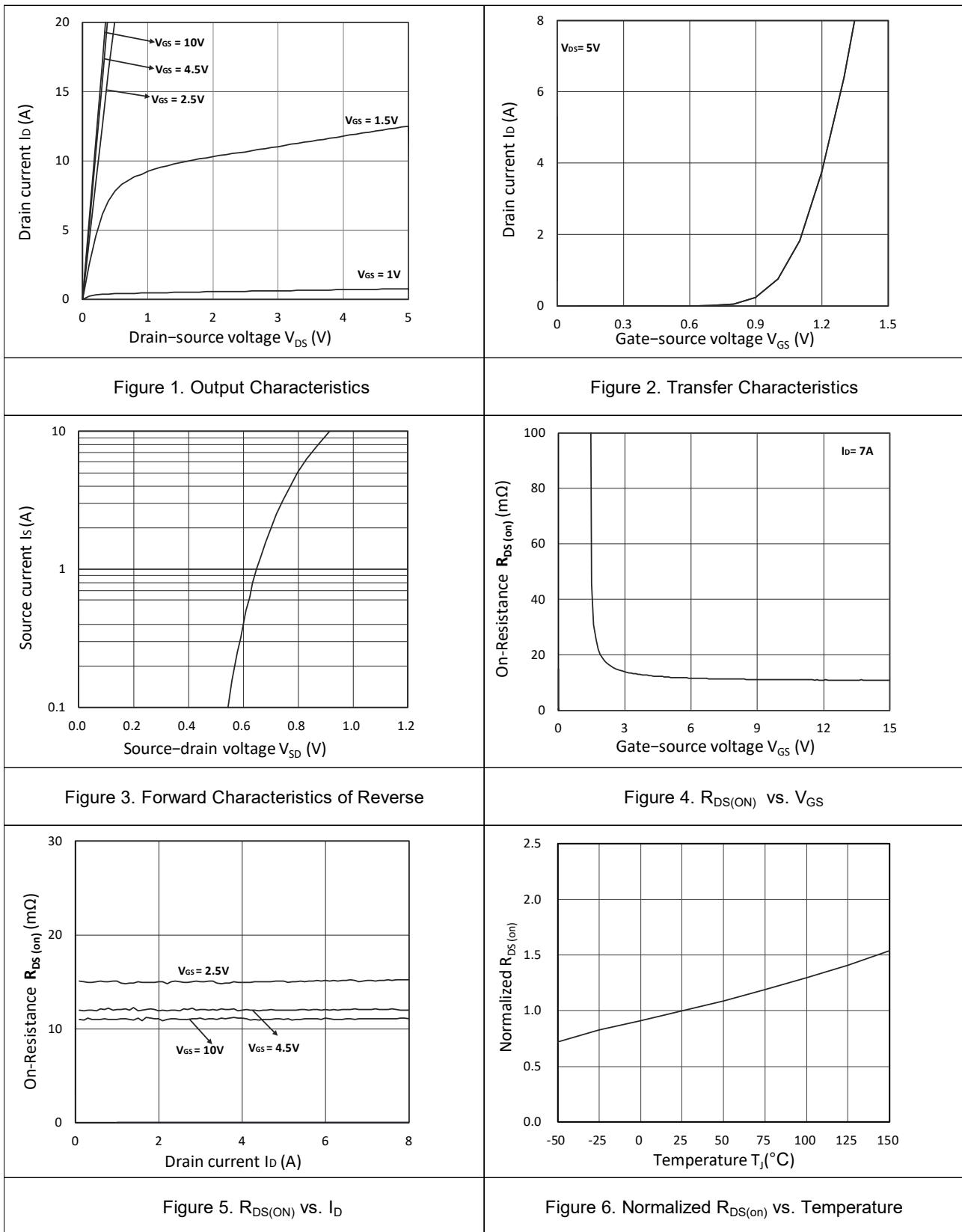
Electrical Characteristics (T_J=25°C unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|--|----------------------|--|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 250μA | 20 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 20V, V _{GS} = 0V | - | - | 1 | μA |
| Gate-body Leakage current | I _{GSS} | V _{DS} = 0V, V _{GS} = ±10V | - | - | ±10 | μA |
| Gate-Threshold Voltage ³ | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250μA | 0.4 | 0.6 | 1 | V |
| Drain-Source on-Resistance ³ | R _{DS(on)} | V _{GS} = 10V, I _D = 5A | - | 11 | 13.5 | mΩ |
| | | V _{GS} = 4.5V, I _D = 4A | - | 12 | 15.5 | |
| | | V _{GS} = 2.5V, I _D = 3A | - | 15 | 18.5 | |
| Dynamic Characteristics⁴ | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = 10V, V _{GS} = 0V, f = 1MHz | - | 771 | - | pF |
| Output Capacitance | C _{oss} | | - | 130 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 102 | - | |
| Switching Characteristics⁴ | | | | | | |
| Total Gate Charge | Q _g | V _{GS} = 10V, V _{DS} = 10V, I _D = 7A | - | 18.7 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 1.9 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 1.4 | - | |
| Turn-on Delay Time | t _{d(on)} | V _{GS} = 10V, V _{DD} = 10V R _G = 3Ω, I _D = 7A | - | 4.5 | - | ns |
| Rise Time | t _r | | - | 10.5 | - | |
| Turn-off Delay Time | t _{d(off)} | | - | 42 | - | |
| Fall Time | t _f | | - | 12 | - | |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage | V _{SD} | I _S = 1A, V _{GS} = 0V | - | - | 1 | V |
| Continuous Source Current | I _S | - | - | - | 7 | A |

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
3. Pulse Test: Pulse width≤300μs, duty cycle≤2%.
4. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics



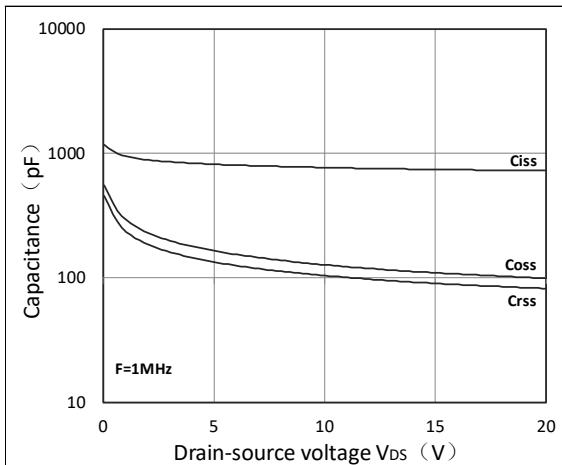


Figure 7. Capacitance Characteristics

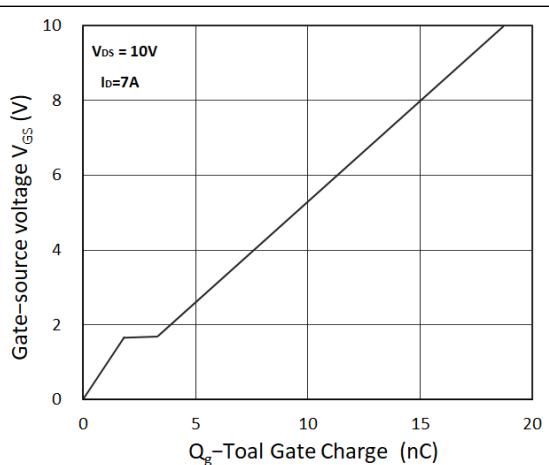
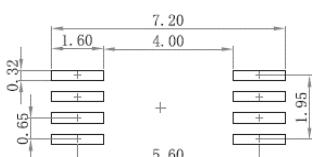


Figure 8. Gate Charge Characteristics

Outline Drawing –TSSOP-8L

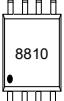
| PACKAGE OUTLINE | | DIMENSIONS | | | |
|-----------------|------------|------------|-----------|-------|--|
| SYMBOL | MILLIMETER | | INCHES | | |
| | MIN | MAX | MIN | MAX | |
| A | 0.85 | 1.20 | 0.033 | 0.047 | |
| a1 | 0.05 | 0.20 | 0.002 | 0.008 | |
| b | 0.19 | 0.30 | 0.007 | 0.012 | |
| b1 | 0.09 | 0.20 | 0.004 | 0.008 | |
| D | 2.90 | 3.10 | 0.114 | 0.122 | |
| E | 6.25 | 6.55 | 0.246 | 0.258 | |
| e | 0.65 BSC | | 0.026 BSC | | |
| F | 4.30 | 4.50 | 0.169 | 0.177 | |
| L | 0.50 | 0.70 | 0.020 | 0.028 | |

Notes:

- Dimensioning and tolerances per ANSI Y14.5M, 1985.
- Controlling Dimension: Inches
- Dimensions are exclusive of mold flash and metal burrs.

Marking Codes

| | |
|--------------|---|
| Part Number | WM02DN70A |
| Marking Code |  |

Package Information

Qty: 4k/Reel

CONTACT INFORMATION

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Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.